

Parameters Subject to Change Without Notice

DESCRIPTION

The JW[®]5052C is a current mode monolithic buck voltage converter. Operating with an input range of 4.5V-18V, the JW5052C delivers 2A of continuous output current with two integrated N-Channel MOSFETs. At light loads, regulators operate in low frequency to maintain high efficiency and low output ripple.

The JW5052C guarantees robustness with short circuit protection, thermal protection, current run-away protection, and input under voltage lockout.

The JW5052C is available in a 6-pin SOT23-6 package, which provides a compact solution with minimal external components.

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FEATURES

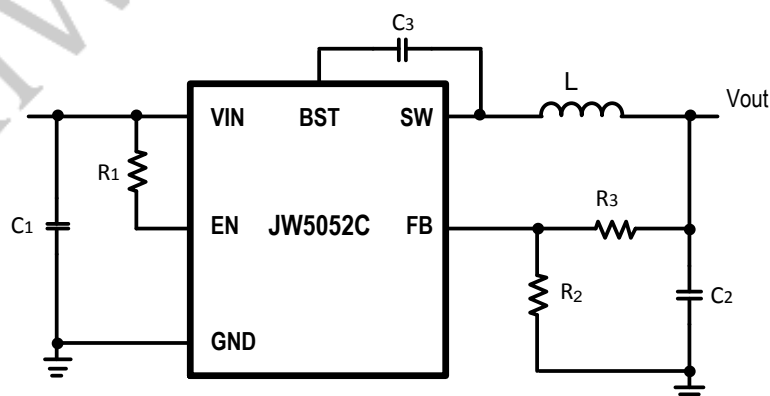
- 4.5V to 18V operating input range
- 2A output current
- Up to 93% efficiency
- High efficiency at light load
- 700kHz Switching frequency
- Input under voltage lockout
- Start-up current run-away protection
- Over current protection and Hiccup
- Thermal protection
- Available in SOT23-6 package

APPLICATIONS

- Distributed Power Systems
- Networking Systems
- FPGA, DSP, ASIC Power Supplies
- Green Electronics/ Appliances
- Notebook Computers

TYPICAL APPLICATION

2A Step Down Regulator



ORDER INFORMATION

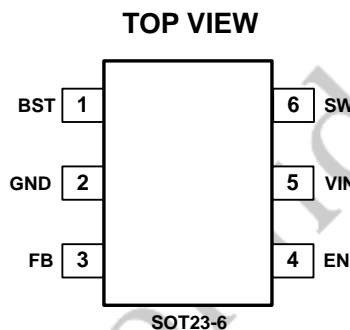
DEVICE ¹⁾	PACKAGE	TOP MARKING ²⁾
JW5052CSOTB#TRPBF	SOT23-6	JWH6□ YW□□□

Notes:

1) JW□□□#TRPBF
 PB Free
 Tape and Reel(If "TR" is not shown, it means tube)
 Package Code
 Part No.

2) Line1: JW□□□ Internal control code
 Product code
 Joulwatt LOGO
 Line2: YW□□□ Lot number
 Week code
 Year code

PIN CONFIGURATION

ABSOLUTE MAXIMUM RATING¹⁾

VIN, EN Pin	-0.3V to 20V
SW.....	-0.3V(-4.5V for 10ns) to 20V(22V for 10ns)
BST Pin	SW-0.3V to SW+5V
All other Pins	-0.3V to 6V
Junction Temp. ^{2) 3)}	150°C
Lead Temperature	260°C
ESD Susceptibility (Human Body Model)	2kV

RECOMMENDED OPERATING CONDITIONS

Input Voltage VIN	4.5V to 18V
Output Voltage Vout	0.6V to VIN-3V

THERMAL PERFORMANCE⁴⁾

Absolute Max Storage Temp.	Recommended Operating Junction Temp. Range	Recommended Max Case Temp. T_c (°C)	Abs. Max Junction Temp. T_j (°C)	Recommended Max Power Loss $P_D@25^\circ\text{C}$ (W)
-65°C to 150°C	-40°C to 125°C	122	150	0.45
$R_{\theta JC}$ (°C/W)	$R_{\theta JA}$ (°C/W)	$R_{\theta JB}$ (°C/W)	ψ_{JT} (°C/W)	ψ_{JB} (°C/W)
130	220	36.1	2.3	35.3

Note:

- 1) Exceeding these ratings may damage the device.
- 2) The JW5052C guarantees robust performance from -40°C to 150°C junction temperature. The junction temperature range specification is assured by design, characterization and correlation with statistical process controls.
- 3) The JW5052C includes thermal protection that is intended to protect the device in overload conditions. Thermal protection is active when junction temperature exceeds the maximum operating junction temperature. Continuous operation over the specified absolute maximum operating junction temperature may damage the device.
- 4) Measured on JESD51-7, 4-layer PCB

ELECTRICAL CHARACTERISTICS

<i>V_{IN}=12V, T_A=25 °C, Unless otherwise stated.</i>						
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
V _{IN} Under Voltage Lock-out Threshold	V _{IN_MIN}	V _{IN} Rising	3.85	4.2	4.45	V
V _{IN} Under voltage Lockout Hysteresis ⁵⁾	V _{IN_MIN_HYST}			300		mV
Shutdown Supply Current	I _{SD}	V _{EN} =0V		0.1	1	μA
Supply Current	I _Q	V _{EN} =5V, V _{FB} =1.2V		100	130	μA
Feedback Voltage	V _{FB}	4.5V<V _{IN} <18V	588	600	612	mV
Top Switch Resistance ⁵⁾	R _{DS(ON)T}			130		mΩ
Bottom Switch Resistance ⁵⁾	R _{DS(ON)B}			70		mΩ
Top Switch Leakage Current	I _{LEAK_TOP}	V _{IN} =18V, V _{EN} =0V, V _{SW} =0V		0.1	1	μA
Bottom Switch Leakage Current	I _{LEAK_BOT}	V _{IN} =18V, V _{EN} =0V, V _{SW} =18V		0.1	1	μA
Top Switch Current Limit ⁵⁾	I _{LIM_TOP}	Minimum Duty Cycle	3.2	3.9	4.6	A
Bottom Switch Current Limit ⁵⁾	I _{LIM_BOT}		2.2	2.7	3.2	A
Switch Frequency	F _{SW}		560	700	800	kHz
Minimum On Time ⁵⁾	T _{ON_MIN}			120		ns
Minimum Off Time ⁵⁾	T _{OFF_MIN}	V _{FB} =0.4V		150		ns
EN High Level Input Voltage	V _{EN_H}	V _{EN} Rising	1.45			V
EN Low Level Input Voltage	V _{EN_L}	V _{EN} Falling			0.6	V
Thermal Shutdown ⁵⁾	T _{TSD}			150		°C
Thermal Shutdown hysteresis ⁵⁾	T _{TSD_HYST}			20		°C

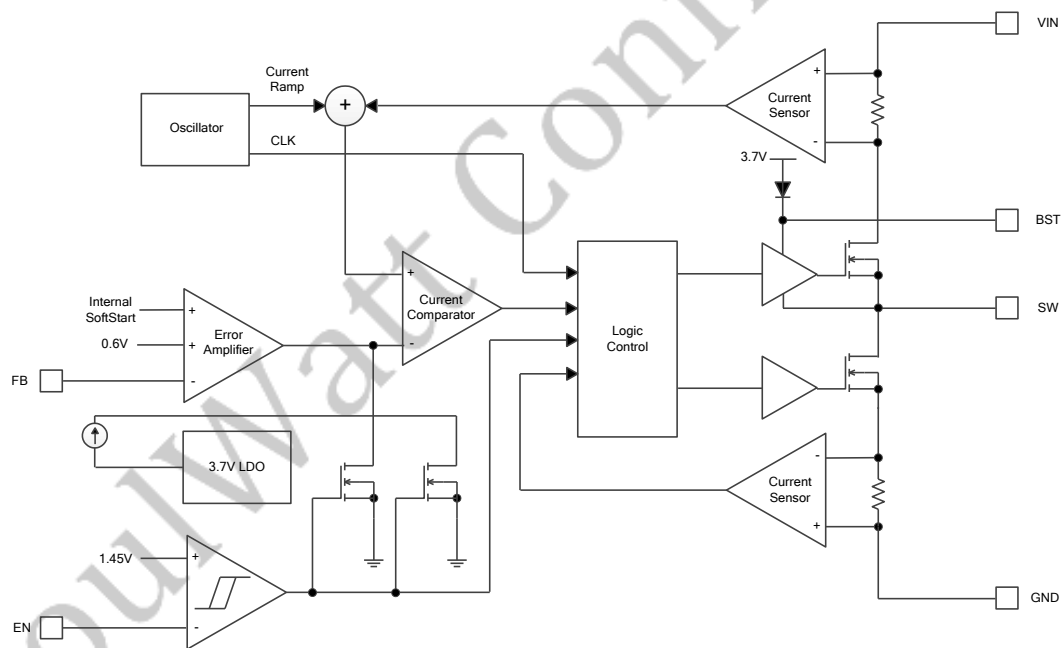
Note:

5) Guaranteed by design.

PIN DESCRIPTION

Pin	Name	Description
1	BST	Bootstrap pin for top switch. A 0.1uF or larger capacitor should be connected between this pin and the SW pin to supply current to the top switch and top switch driver.
2	GND	Ground.
3	FB	Output feedback pin. FB senses the output voltage and is regulated by the control loop to 0.6V. Connect a resistive divider at FB.
4	EN	Drive EN pin high to turn on the regulator and low to turn off the regulator.
5	VIN	Input voltage pin. VIN supplies power to the IC. Connect a 4.5V to 18V supply to VIN and bypass VIN to GND with a suitably large capacitor to eliminate noise on the input to the IC.
6	SW	SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load.

BLOCK DIAGRAM

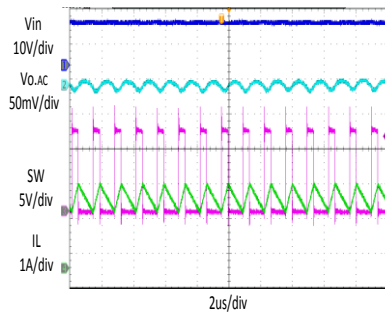


TYPICAL PERFORMANCE CHARACTERISTICS

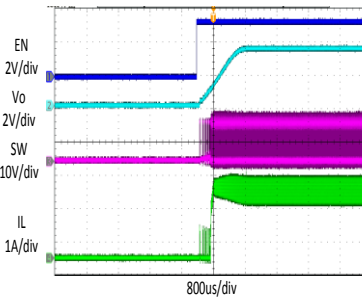
$V_{in} = 12V$, $V_{out} = 3.3V$, $L = 4.7\mu H$, $C_{out} = 22\mu F$, $T_A = +25^\circ C$, unless otherwise noted

Steady State Test

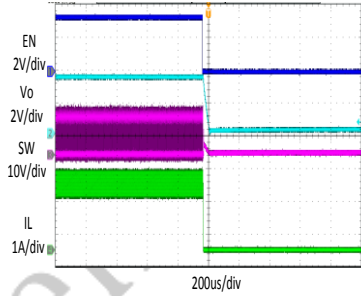
$V_{in}=12V$, $V_{out}=3.3V$
 $I_{out}=2A$

**Startup through Enable**

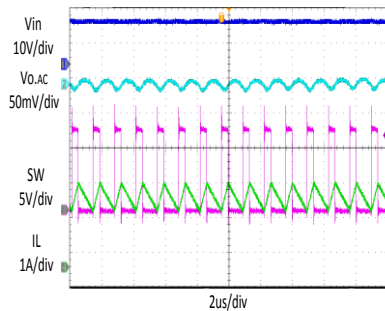
$V_{in}=12V$, $V_{out}=3.3V$
 $I_{out}=2A$ (Resistive load)

**Shutdown through Enable**

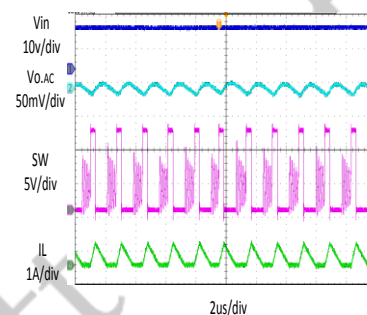
$V_{in}=12V$, $V_{out}=3.3V$
 $I_{out}=2A$ (Resistive load)

**Heavy Load Operation**

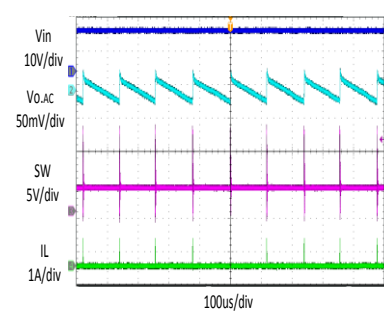
2A LOAD

**Medium Load Operation**

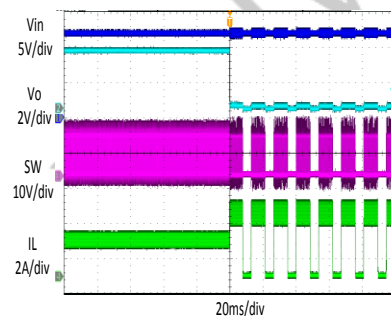
0.2A LOAD

**Light Load Operation**

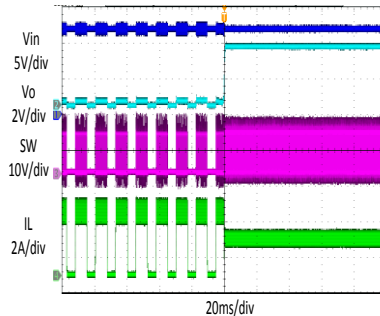
0A LOAD

**Short Circuit Protection**

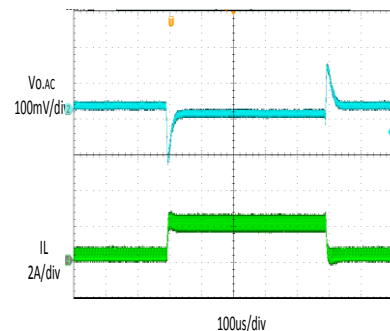
$V_{in}=12V$, $V_{out}=3.3V$
 $I_{out}=2A$ - Short

**Short Circuit Recovery**

$V_{in}=12V$, $V_{out}=3.3V$
 I_{out} = Short-2A

**Load Transient**

0.2A LOAD \rightarrow 2A LOAD \rightarrow 0.2A LOAD



TYPICAL PERFORMANCE CHARACTERISTICS

$V_{in} = 12V$, $V_{out} = 3.3V$, $L = 4.7\mu H$, $C_{out} = 22\mu F$, $T_A = +25^\circ C$, unless otherwise noted

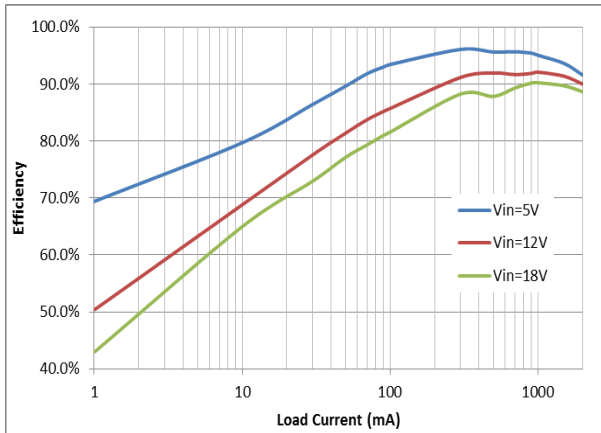


Figure 1. Efficiency vs Load Current
($V_{out}=3.3V$, $L=4.7\mu H$)

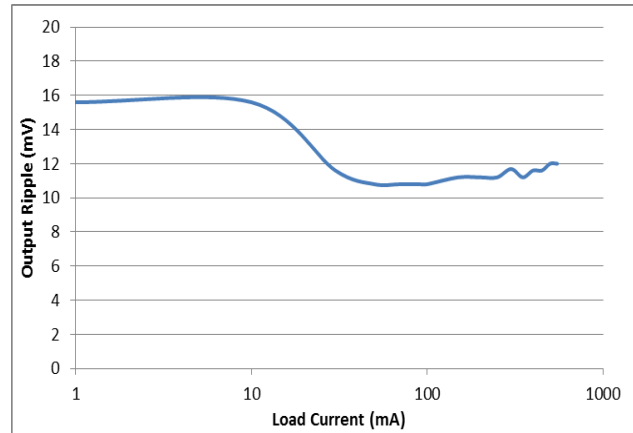


Figure 2. Output Ripple vs Load Current
($V_{in}=12V$, $V_{out}=3.3V$, $L=4.7\mu H$)

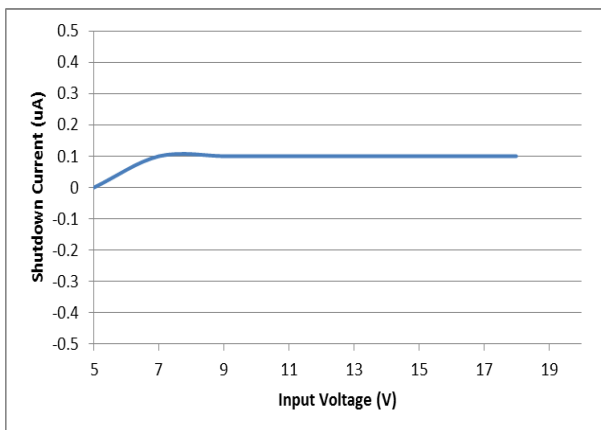


Figure 3. Shutdown Current vs Input Voltage
($V_{out}=3.3V$, $L=4.7\mu H$)

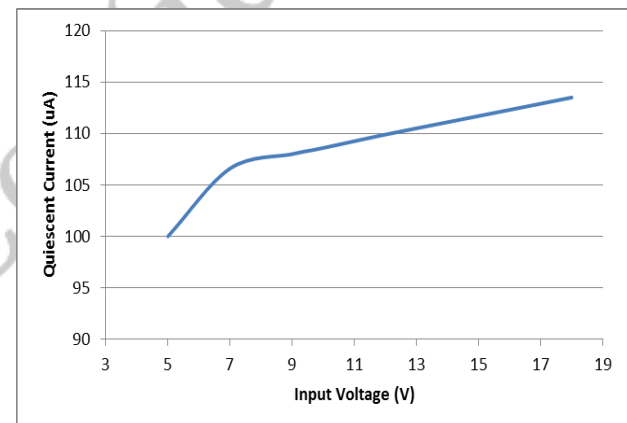


Figure 4. Quiescent Current vs Input Voltage
($V_{out}=3.3V$, $L=4.7\mu H$)

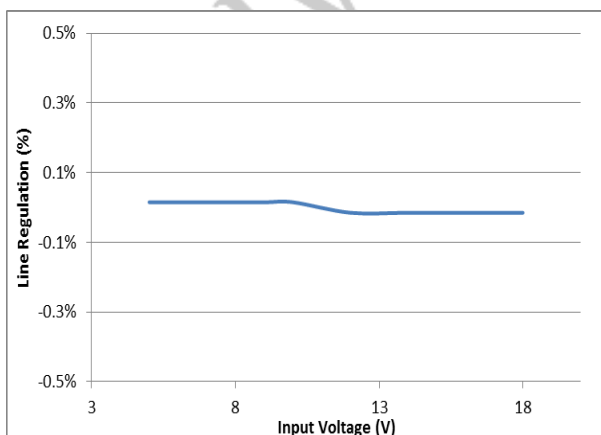


Figure 5. Line Regulation vs Input Voltage
($V_{out}=3.3V$, $L=4.7\mu H$)

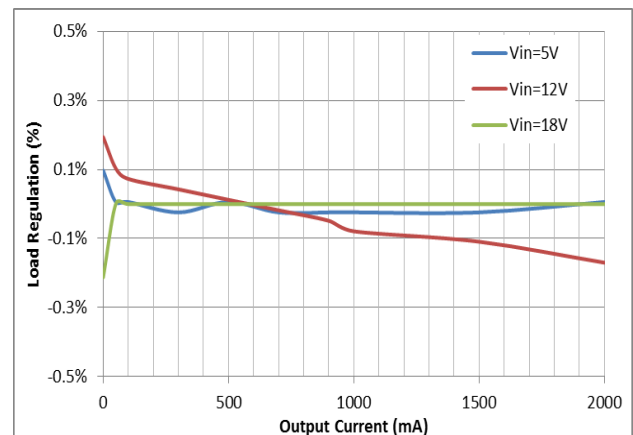


Figure 6. Load Regulation vs Output Current
($V_{out}=3.3V$, $L=4.7\mu H$)

FUNCTIONAL DESCRIPTION

The JW5052C is a synchronous, current-mode, step-down regulator. It regulates input voltages from 4.5V to 18V down to an output voltage as low as 0.6V, and is capable of supplying up to 2A of load current.

Current-Mode Control

The JW5052C utilizes current-mode control to regulate the FB voltage. Voltage at the FB pin is regulated at 0.6V so that by connecting an appropriate resistive divider between VOUT and GND, designed output voltage can be achieved.

PFM Mode

The JW5052C operates in PFM mode at light load. In PFM mode, switch frequency decreases when load current drops to boost power efficiency at light load by reducing switch-loss, while switch frequency increases when load current rises, minimizing output voltage ripples.

Internal Soft-Start.

Soft-Start makes output voltage rising smoothly follow an internal SS voltage until SS voltage is higher than the internal reference voltage. It can prevent overshoot of output voltage when startup.

Power Switch

N-Channel MOSFET switches are integrated on the JW5052C to down convert the input voltage to the regulated output voltage. Since the top MOSFET needs a gate voltage greater than the input voltage, a boost capacitor connected between BST and SW pins is required to drive the gate of the top switch. The boost capacitor is charged by the internal 3.7V rail when SW is low.

Vin Under-Voltage Protection

A resistive divider can be connected between Vin and GND, with the central tap connected to EN, so that when Vin drops to the pre-set value, EN drops below 1.2V to trigger input under voltage lockout protection.

Output Current Run-Away Protection

At start-up, due to the high voltage at input and low voltage at output, current inertia of the output inductance can be easily built up, resulting in a large start-up output current. A valley current limit is designed in the JW5052C so that only when output current drops below the valley current limit can the top power switch be turned on. By such control mechanism, the output current at start-up is well controlled.

Over Current Protection and Hiccup

JW5052C has a cycle-by-cycle current limit. When the inductor current triggers current limit, JW5052C enters hiccup mode and periodically restart the chip.

JW5052C exits hiccup mode while not triggering current limit.

Thermal Protection

When the temperature of the JW5052C rises above 150°C, it is forced into thermal shut-down.

Only when core temperature drops below 135°C can the regulator becomes active again.

APPLICATION INFORMATION

Output Voltage Set

The output voltage is determined by the resistor divider connected at the FB pin, and the voltage ratio is:

$$V_{FB} = V_{OUT} \cdot \frac{R_2}{R_2 + R_3}$$

where V_{FB} is the feedback voltage and V_{OUT} is the output voltage.

Choose R_2 around 10k Ω , and then R_3 can be calculated by:

$$R_3 = R_2 \left(\frac{V_{OUT}}{0.6V} - 1 \right)$$

Too large resistance and the following table lists the recommended values.

V _{OUT} (V)	R ₂ (k Ω)	R ₃ (k Ω)
2.5	10	31.6
3.3	11	49.9
5	15	110

Input Capacitor

The input capacitor is used to supply the AC input current to the step-down converter and maintaining the DC input voltage. The ripple current through the input capacitor can be calculated by:

$$I_{C1} = I_{LOAD} \cdot \sqrt{\frac{V_{OUT}}{V_{IN}} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}} \right)}$$

where I_{LOAD} is the load current, V_{OUT} is the output voltage, V_{IN} is the input voltage.

Thus the input capacitor can be calculated by the following equation when the input ripple voltage is determined.

$$C_1 = \frac{I_{LOAD}}{f_s \cdot \Delta V_{IN}} \cdot \frac{V_{OUT}}{V_{IN}} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

where C_1 is the input capacitance value, f_s is the switching frequency, ΔV_{IN} is the input ripple voltage.

The input capacitor can be electrolytic, tantalum or ceramic. To minimizing the potential noise, a small X5R or X7R ceramic capacitor, i.e. 0.1 μ F, should be placed as close to the IC as possible when using electrolytic capacitors.

A 22 μ F ceramic capacitor is recommended in typical application.

Output Capacitor

The output capacitor is required to maintain the DC output voltage, and the capacitance value determines the output ripple voltage. The output voltage ripple can be calculated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_s \cdot L} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}} \right) \cdot \left(R_{ESR} + \frac{1}{8 \cdot f_s \cdot C_2} \right)$$

where C_2 is the output capacitance value and R_{ESR} is the equivalent series resistance value of the output capacitor.

The output capacitor can be low ESR electrolytic, tantalum or ceramic, which lower ESR capacitors get lower output ripple voltage.

The output capacitors also affect the system stability and transient response, and a 22 μ F ceramic capacitor is recommended in typical application.

Inductor

The inductor is used to supply constant current to the output load, and the value determines the ripple current which affect the efficiency and the output voltage ripple. The ripple current is typically allowed to be 40% of the maximum

switch current limit, thus the inductance value can be calculated by:

$$L = \frac{V_{OUT}}{f_s \cdot \Delta I_L} \cdot \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

where V_{IN} is the input voltage, V_{OUT} is the output voltage, f_s is the switching frequency, and ΔI_L is the peak-to-peak inductor ripple current.

External Bootstrap Capacitor

A bootstrap capacitor is required to supply voltage to the top switch driver. A 0.1 μ F low ESR ceramic capacitor is recommended to be connected to the BST pin and SW pin.

PCB Layout Note

For minimum noise problem and best operating performance, the PCB is preferred to following the guidelines as reference.

1. Place the input decoupling capacitor as close to JW5052C (VIN pin and PGND) as possible to eliminate noise at the input pin. The loop area formed by input capacitor and GND must be minimized.
2. Put the feedback trace as far away from the inductor and noisy power traces as possible.
3. The ground plane on the PCB should be as large as possible for better heat dissipation.

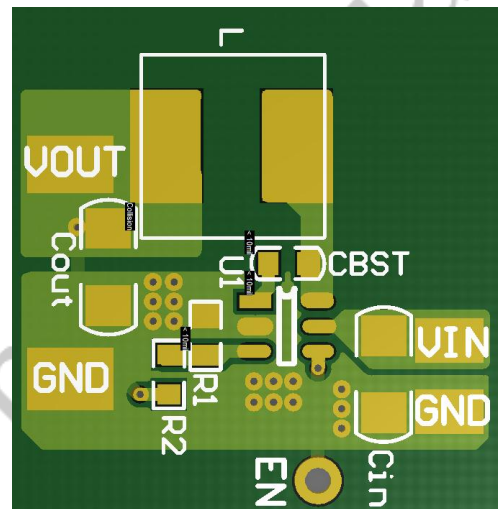
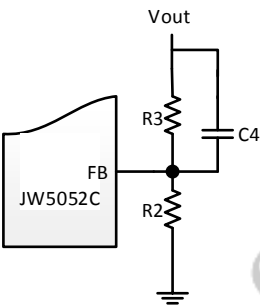


Figure1. PCB Layout Recommendation

External Components Suggestion:

VOUT(V)	R2 (kΩ)	R3 (kΩ)	C4 (pF)	L(uH)	Cout(uF)
1	10.2	6.8	NC~20	2.2~4.7	44~66
1.2	10.2	10.2	NC~20	2.2~4.7	44~66
1.5	10	15	NC~20	2.2~4.7	44~66
2.5	10	31.6	NC~20	2.2~4.7	22~66
3.3	11	49.9	NC~20	2.2~4.7	22~66
5	15	110	NC~20	2.2~4.7	22~66

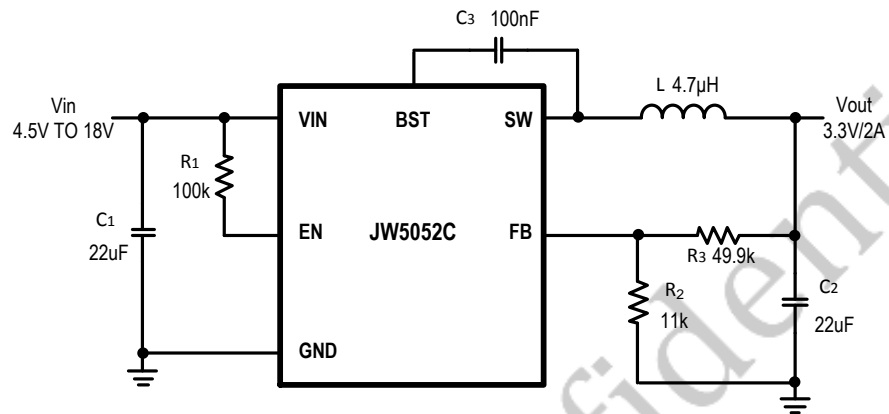


REFERENCE DESIGN

Reference 1:

 V_{IN} : 4.5V ~ 18V

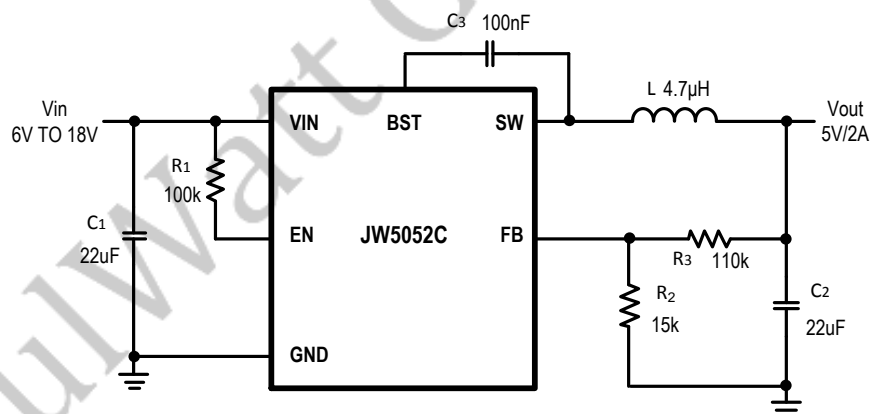
 V_{OUT} : 3.3V

 I_{OUT} : 0~2A


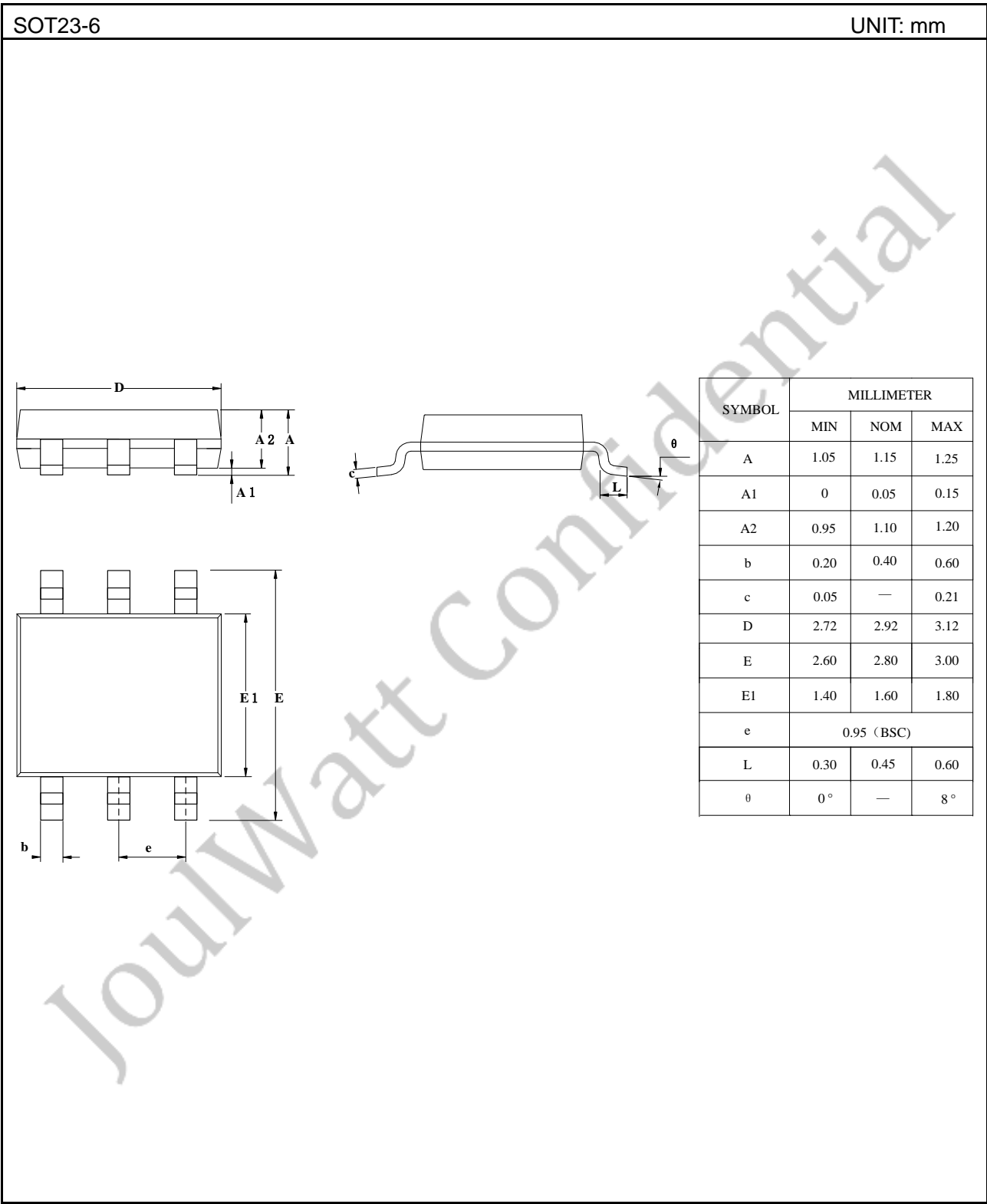
Reference 2:

 V_{IN} : 6V ~ 18V

 V_{OUT} : 5V

 I_{OUT} : 0~2A


PACKAGE OUTLINE



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